

SiC Schottky Barrier Diode

TRS8E65C

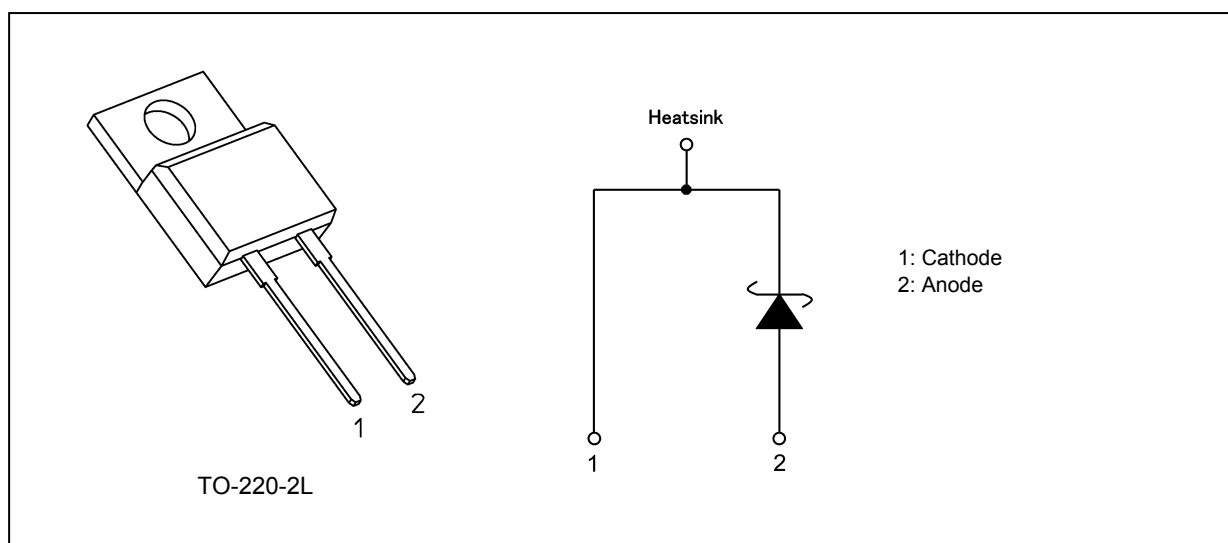
1. Applications

- Power Factor Correction
- Solar Inverters
- Uninterruptible Power Supplies
- DC-DC Converters

2. Features

- (1) Forward DC current: $I_{F(DC)} = 8\text{ A}$
- (2) Repetitive peak reverse voltage: $V_{RRM} = 650\text{ V}$

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25\text{ °C}$)

Characteristics	Symbol	Note	Rating	Unit
Repetitive peak reverse voltage	V_{RRM}		650	V
Forward DC current	$I_{F(DC)}$		8	A
Forward pulse current	I_{FP}	(Note 1)	90	
I^2t limit value	I^2t	(Note 2)	8.0	A ² s
Junction temperature	T_j		175	°C
Storage temperature	T_{stg}		-55 to 175	
Mounting torque	TOR		0.6	N · m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: $t = 100\mu\text{s}$

Note 2: $f = 50\text{ Hz}$

Start of commercial production

2013-07

5. Thermal Characteristics

Characteristics	Symbol	Test Condition	Max	Unit
Thermal resistance (junction-to-case)	$R_{th(j-c)}$	—	2.35	°C/W
Thermal resistance (junction-to-ambient)	$R_{th(j-a)}$	—	89	

6. Electrical Characteristics (Unless otherwise specified, $T_a = 25\text{ °C}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	$V_{FM(1)}$	$I_F = 4\text{ A}$ (pulse measurement)	—	1.27	—	V
	$V_{FM(2)}$	$I_F = 8\text{ A}$ (pulse measurement)	—	1.50	1.70	
Repetitive peak reverse current	$I_{RRM(1)}$	$V_{RRM} = 300\text{ V}$ (pulse measurement)	—	0.0008	—	μA
	$I_{RRM(2)}$	$V_{RRM} = 650\text{ V}$ (pulse measurement)	—	0.4	90	
Junction capacitance	C_j	$V_R = 650\text{ V}$, $f = 1\text{ MHz}$	—	44	—	pF

7. Marking

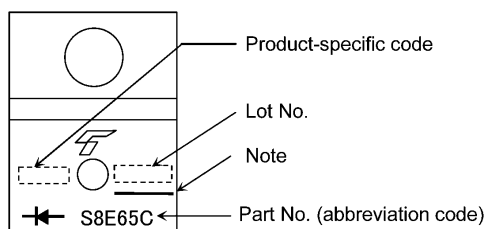


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Abbreviation Code	Part Number
S8E65C	TRS8E65C

8. Usage Considerations

(1) The absolute maximum ratings are rated values that must not be exceeded during operation, even for an instant. The following are the recommended general derating methods for designing a circuit board using this device.

V_{RRM} : V_{RRM} has a temperature coefficient of 0.1 %/°C.

Take this coefficient into account when designing a circuit board that will be operated in a low-temperature environment.

$I_{F(DC)}$: We recommend that the worst-case current be no greater than 80 % of the absolute maximum rating of $I_{F(DC)}$ and that the worst-case junction temperature, T_j , be kept below 140 °C.

I_{FP} : We recommend that the worst-case current be no greater than 80 % of the absolute maximum rating of I_{FP} and that the worst-case junction temperature, T_j , be kept below 140 °C.

I^2t : This rating specifies a non-repetitive limit value.

This only applies to an abnormal operation, which seldom occurs during the lifespan of a device.

T_j : Derate device parameters in proportion to this rating in order to ensure high reliability.

We recommend that the junction temperature (T_j) of a device be kept below 140 °C.

(2) For other design considerations, see the Rectifiers databook or the Toshiba Semiconductor website.

9. Characteristics Curves (Note)

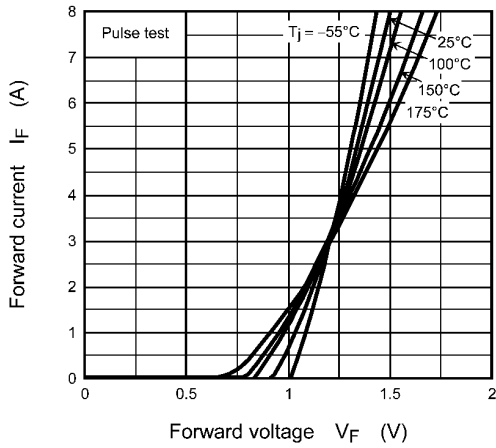


Fig. 9.1 $I_F - V_F$

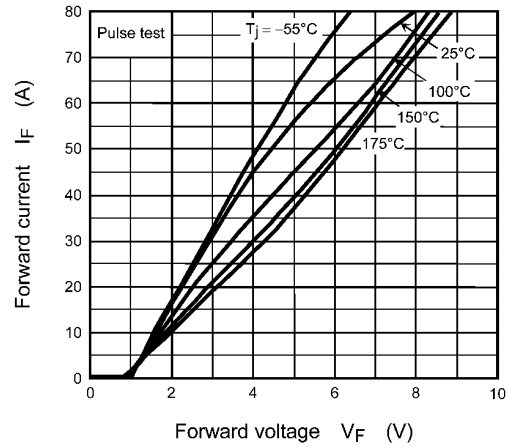


Fig. 9.2 $I_F - V_F$

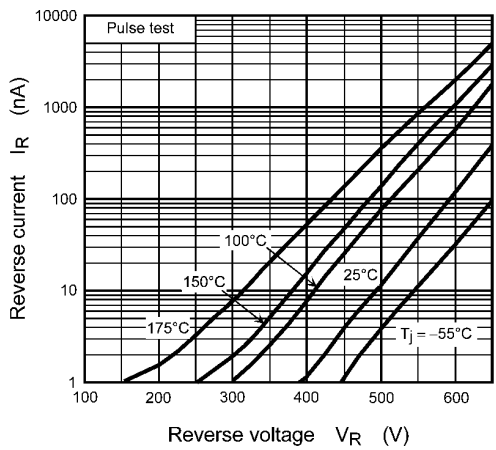


Fig. 9.3 $I_R - V_R$

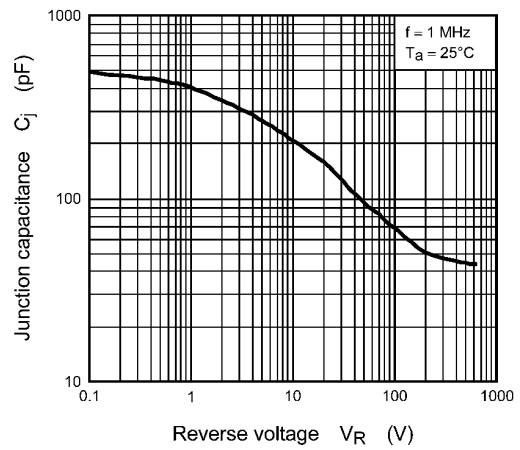
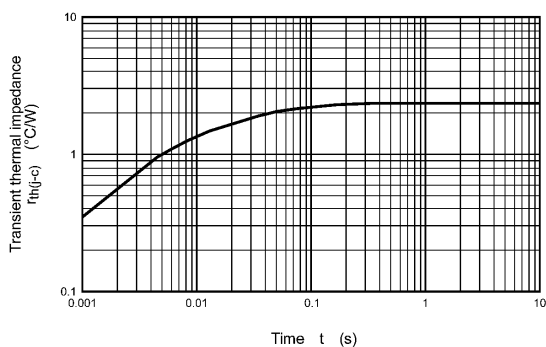


Fig. 9.4 $C_j - V_R$

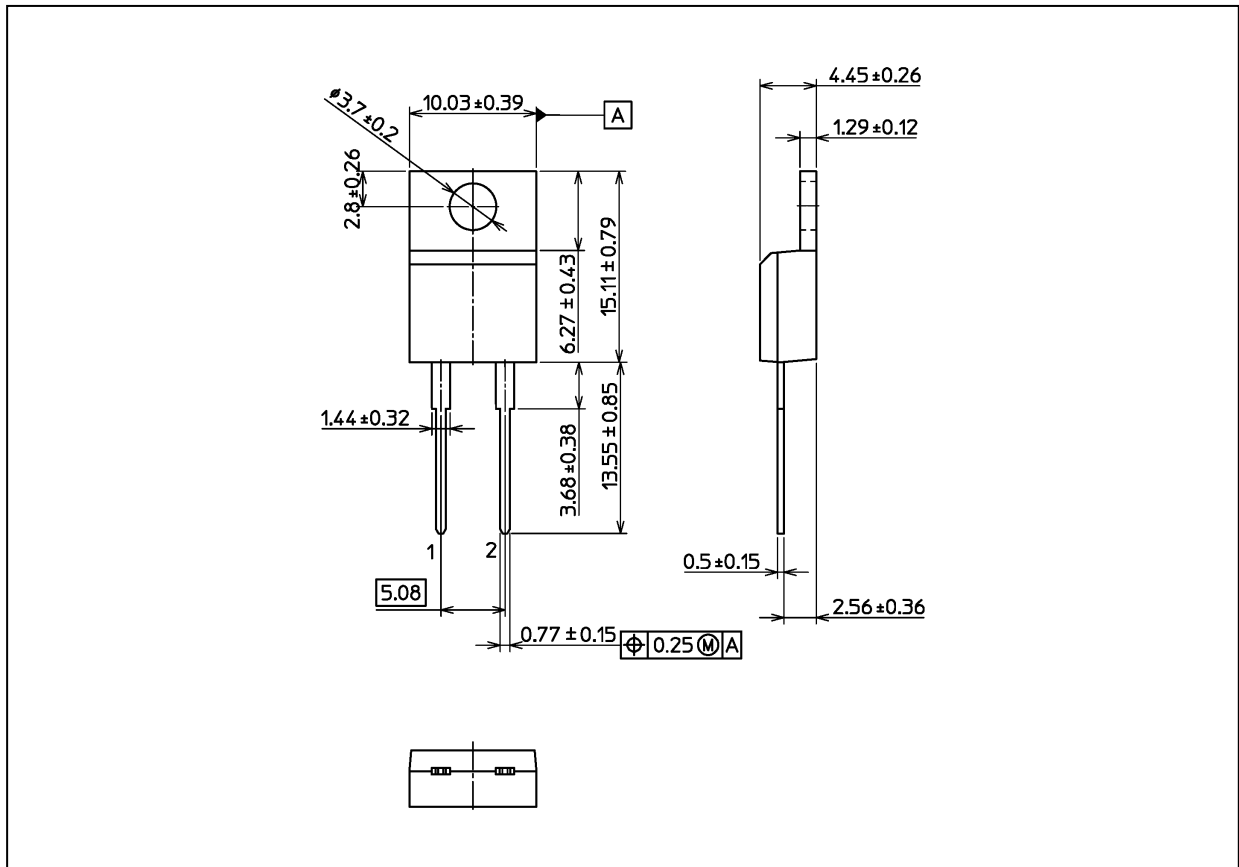


**Fig. 9.5 $r_{th(j-c)} - t$
(Guaranteed Maximum)**

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 1.9 g (typ.)

Package Name(s)
TOSHIBA: 2-10AA1A
Nickname: TO-220-2L

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